JJMICROELECTRONICS

-30V, -80A, 5.2m Ω P-channel Power Trench MOSFET

JMTG050P03A

Features

- Excellent $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})}$ and Low Gate Charge
- 100% UIS TESTED
- 100% ΔVds TESTED
- Halogen-free; RoHS-compliant
- Pb-free plating

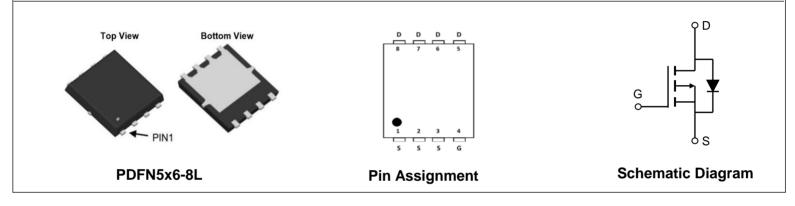
Applications

- Load Switch
- PWM Application
- Power Management

Product Summary

Parameters	Value	Unit
V _{DSS}	-30	V
V _{GS(th)_Typ}	-1.7	V
I _D (@V _{GS} =-10V)	-80	А
R _{DS(ON)_Typ} (@V _{GS} =-10V	3.7	mΩ
R _{DS(ON)_Typ} (@V _{GS} =-4.5V	5.2	mΩ





Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMTG050P03A	G050P03A	1	Tape&Reel	PDFN5x6-8L	5000	50000

Absolute Maximum Ratings (@ T_c = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V _{DS}	Drain-to-Source Voltage		-30	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	$T_C = 25^{\circ}C$	-80	Α
Ι _D		$T_{\rm C} = 100^{\circ}{\rm C}$	-57	~
I _{DM}	Pulsed Drain Current ⁽¹⁾		Refer to Fig.4	A
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		363	mJ
P _D	Power Dissipation	$T_{C} = 25^{\circ}C$	52	W
		$T_{\rm C} = 100^{\circ}{\rm C}$	21	VV
T _J , T _{STG}	Junction & Storage Temperature Range		-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Мах	Unit
R_{\thetaJA}	Thermal Resistance, Junction to Ambient ⁽³⁾	43	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.4	0/22

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS} = 0V$	-	-	-1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1.2	-1.7	-2.2	V
D		$V_{GS} = -10V, I_D = -20A$	-	3.7	4.1	mΩ
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = -4.5V, I_{D} = -10A$	-	5.2	6.6	mΩ
Dynami	ic Characteristics					
R_g	Gate Resistance	f = 1MHz	-	3.9	-	Ω
C_{iss}	Input Capacitance		-	7747	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = -15V,$ f = 1MHz	-	871	-	pF
C _{rss}	Reverse Transfer Capacitance		-	559	-	pF
Qg	Total Gate Charge		-	121	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } -10V$ $V_{DS} = -15V, I_D = -20A$	-	23	-	nC
Q_gd	Gate Drain("Miller") Charge	VDS = 10V, 10 = 20/V	-	18	-	nC
Switchi	ng Characteristics	- I I		1	1	
t _{d(on)}	Turn-On DelayTime		-	28	-	ns
t _r	Turn-On Rise Time	$V_{GS} = -10V, V_{DD} = -15V$	-	83	-	ns
t _{d(off)}	Turn-Off DelayTime	I_D = -20A, R_{GEN} = 3 Ω	-	77	-	ns
t _f	Turn-Off Fall Time		-	66	-	ns
Body D	iode Characteristics				•	
I _S	Maximum Continuous Body Diode Forward Current		-	-	-80	А
I _{SM}	Maximum Pulsed Body Diode Forward Current		-	-	-320	А
$\rm V_{SD}$	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = -30A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	I _F = -20A, di/dt = 100A/us	-	30	-	ns
Qrr	Body Diode Reverse Recovery Charge	$_{\rm F} = -20$ A, u/ul = 100 A/us	-	19.5	-	nC

Electrical Characteristics ($T_J = 25^{\circ}C$ unless otherwise specified)

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

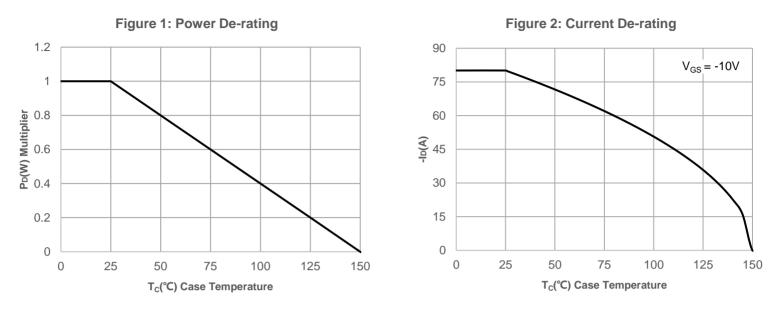
 $2. \ E_{AS} \ \text{condition: Starting } T_J = 25C, \ V_{DD} = -15V, \ V_G = -10V, \ R_G = 250hm, \ L = 0.5mH, \ I_{AS} = -38.08A, \ V_{DD} = 0V \ during \ time \ in \ avalanche.$

3. $R_{\theta JA}$ is measured with the device mounted on a 1inch 2 pad of 2oz copper FR4 PCB.

4. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.







Typical Performance Characteristics



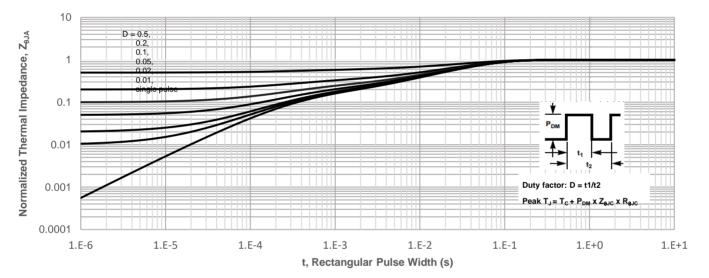
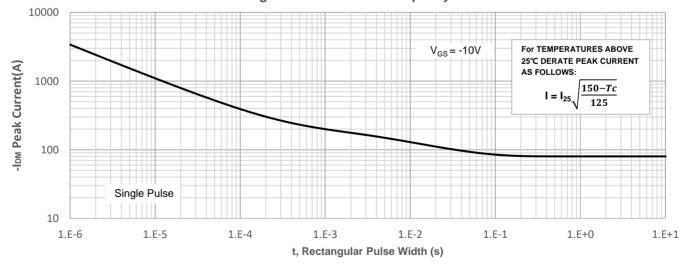


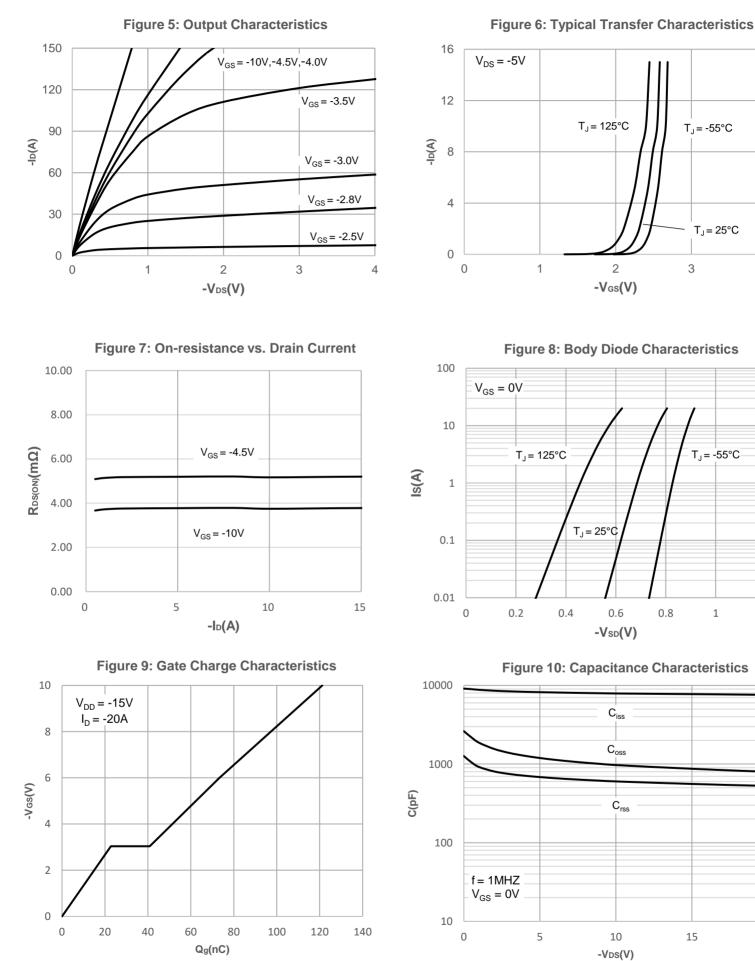
Figure 4: Peak Current Capacity



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1.2

1



Typical Performance Characteristics

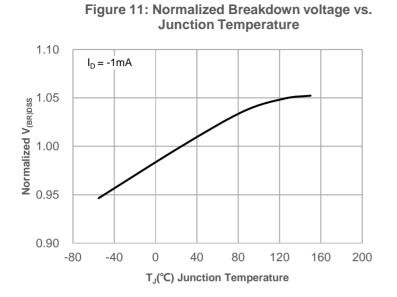
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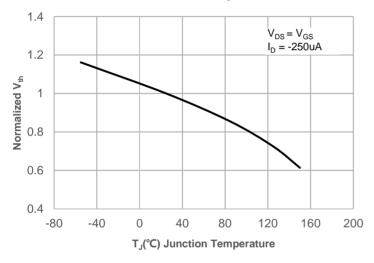
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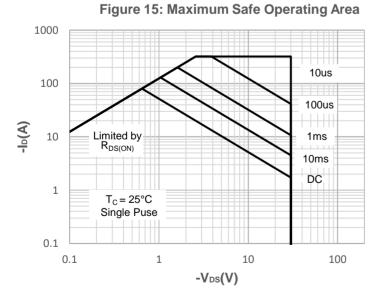


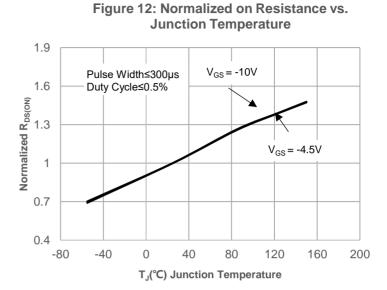
Typical Performance Characteristics

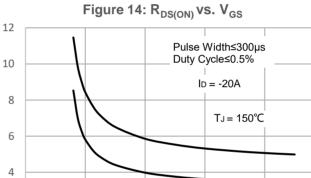


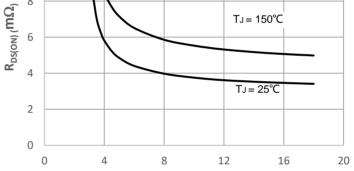










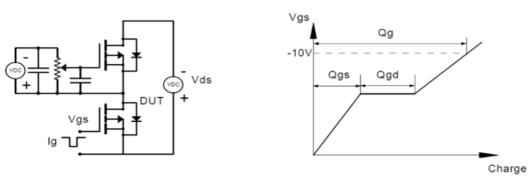


-V_{GS}(V)

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Test Circuit





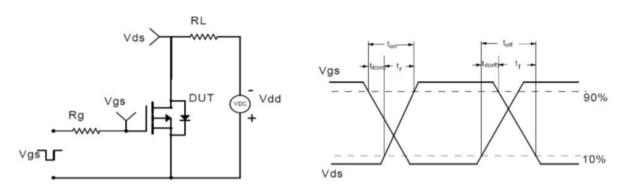


Figure 2: Resistive Switching Test Circuit & Waveform

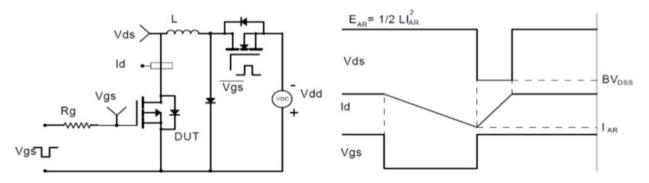


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

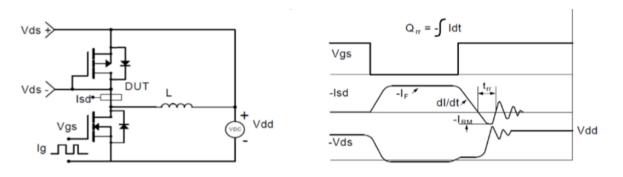
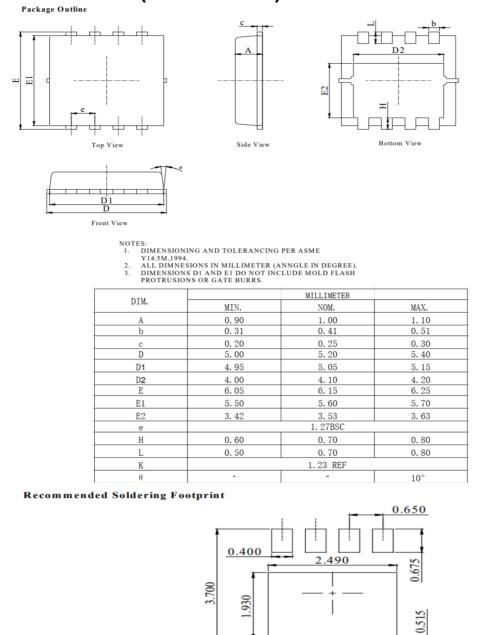


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(PDFN5X6-8L)



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